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# Introduction

- Future hadron colliders challenge the tracking and reconstruction with high rates and huge pile-up
- ATLAS and CMS already aim for 30-40ps timing resolution, future trackers like FCC will demand timing of 5ps while still providing position resolution below 10 μm in high density environments
- Silicon sensors are proven to be very radiation hard and have a short charge collection time – current and future choice for tracking detectors
- Many collaborations working on improving time resolution, e.g.
  Ultra Fast Silicon Detectors (UFSDs LGADs)
  - Working on improving radiation hardness (gain layer degradation)
  - ➡3D pixel sensors dedicated for timing: RD50 project
    - Potential alternative: proven radiation hardness, gain increase



Tracking z-resolution larger than vertexseparation: Ambiguous Track-to-vertex association





#### 3D sensors





**Insertable B-Layer production** 

- Double-sided
- 235  $\mu m$  active thickness
- $50 \times 50 \ \mu m^2$  unit cell size
- $100 \times 100 \ \mu m^2$  active area
- Depletion voltage: 5-10 V

#### **ATLAS Inner Tracker pre-production**

- Single-sided
- 150  $\mu m$  active thickness , 270  $\mu m$  total thickness
- Unit cell size:  $50 \times 50 \ \mu m^2$  or  $25 \times 100 \ \mu m^2$
- Active area:  $100 \times 100 \ \mu m^2$  or  $50 \times 200 \ \mu m^2$
- Depletion voltage: 5-10 V



# **Experimental Setups**

- Single pulses recorded of both reference and tested sensor
- About 3000 events with DUT signature for appropriate statistics



- <sup>90</sup>Sr-source
- LGAD reference,  $\sigma_{Ref} = 25.18 \pm 0.35 \ ps$
- PMT yes/no trigger



- Measurements with MIP-like particles and laser source
- If possible, only external triggers



- Top-TCT, infrared laser (1060nm)
- 2 pulses recorded (fiber splitter)
- Intensity tunable



#### Time Resolution: Unirradiated 3D Pixel Sensors

- Low laser intensity MPV around 80-110 mV, low compared to beta set-up (145 mV) •
- Cell structure not as clear as for time resolution, but still fits the expectations
- Rise time between 340 and 420 ps, higher than measured in the beta set-up

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#### Time Resolution: Unirradiated 3D Pixel Sensors

- Time resolution measured at 60 V for a 10x40  $\mu$ m area in 5  $\mu$ m steps and interpolated
- Two sensors measured: Similar cell structure recognisable :
  - > Better resolution closer to the readout column
  - $\succ$  Worse resolution closer to the other junction columns
  - > Range from 23-43 ps/ 25-47 ps
- Differences: Uncertainties in position, laser focus, laser intensity







# Time Resolution: Unirradiated 3D sensors



- Before irradiation, sensors reach about 30-31 ps time resolution at room temperature
- Quadratic geometry performs better
- ATLAS and IBL sensors perform very similar, slightly better rise time (240ps) for ATLAS sensor

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# Time Resolution: 3D vs other sensors



- Planar: Strips sensors  $300\mu$ m thickness (ATLAS, Hamamatsu) and  $150\mu$ m thickness (CMOS, LFoundry)
- LGADs Pad diodes:  $50\mu$ m thickness, high gain layer doping and  $35\mu$ m thickness, lower gain layer doping
- As expected, 3D strip sensors show better time resolutions than planar strip sensors, but only pixel sensors are competitive with LGADs
- Benefit: Lower voltage necessary for 3Ds than for LGADs



## Time Resolution: Irradiated 3D sensors



- Signal decreases with fluence
- Rise time drop after irradiation
- No significant fluence dependence for rise time



### Time Resolution: Irradiated 3D sensors





- Slightly higher bias voltages necessary
- No clear voltage dependence for highest fluences
- Time resolution seems to be slightly improving with fluence

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### **Time Resolution vs Fluence**





#### • Measured at 80V

- Time resolution improves with increasing fluence
- Higher electric field between columns improves timing



# Comparison - LGAD vs 3D Pixel after irradiation



- Significantly lower rise time
- For these 3D pixel and LGAD types: 3D sensors perform better in timing measurements
- Note: This are not the latest/ fastest generation of LGADs but the 3D sensors prove to be competitive





# New Timing 3D sensors





P+ electrodes

- 3D doublesided technology
- Hexagonal geometry, quadratic for comparison
- 285  $\mu m$  active thickness
- 10  $\mu m$  column diameter



#### Designed and produced by CNM



#### RD50 common fast timing

#### project:

CNM, Uni Freiburg, JSI (Ljubljana), IFAE (Barcelona), NIKHEF (Amsterdam), UZH (Zurich)



# New Timing 3D sensors: Simulations

CERN

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Leena Diehl - 3D silicon sensors as timing detectors

# New Timing 3D sensors





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### New Timing 3D sensors: IVs





- 7 different sensor types measured: Depletion voltages between 5-20V
- Several devices per type available: All functional, timing measurement campaign to be started





### **Conclusion and Outlook**

- Time resolution of silicon sensors is an important research area for upcoming and future colliders
- Before irradiation, both 3D sensors reach time resolutions of 30-35 ps, comparable to LGADs
- 3D pixel sensors improve resolution after irradiation while the bias voltage range stays almost the same
- 3D pixels withstand  $5 \times 10^{16} n_{eq}/cm^2$  while keeping their timing performance
- The position dependent time resolution measured correlates very well with the electric field distribution
- Dedicated timing sensors: Hexagonal geometry, IV measurements completed timing measurements to be started soon
- Irradiation campaign to high fluences planned





# Thank you for your attention!





# BACKUP

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#### LGAD Readout Board



- 1. Bonded LGAD
- 2. Amplifier
- 3. High voltage connector
- 4. Readout connector
- 5. Low voltage connector
- 6. PT100 connector
- 7. Lid



# **Time Resolution - Components**

Main components: Jitter and time walk:



• Jitter component  $\sigma_i$ : Determined by the rise time at the amplifier output dV/dt and the noise level  $\sigma_n$ :

 $\sigma_t^2 = \sigma_i^2 + \sigma_{TW}^2$ 



- Time walk component includes:
  - Weighting field/ el. Field contribution
  - Landau fluctuations in signal shape
  - Landau fluctuation in the amount of deposited charge (correctable)
- Time Walk component depends strongly on the sensor design

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# TCT area scans: 3D Pixel Sensors

- TCT scans show very small measurable area for Timing-TCT •
- Outer columns connected indefinite electric field outside the cell •





- 3D strip sensor: 235  $\mu$ m thickness, 80x80 $\mu$ m<sup>2</sup> cell size, 6 channels connected to readout
- Measured with TCT and Timing Set-Up

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• For high voltages: Time resolution of about 75 ps reached





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Position dependent measurement of the time resolution with the TCT, measured at 150 V







- Clear cell structure
- Similar patterns for jitter and rise time
- Both correlate to the expected el. Field
- Rise Time between 810 and 855 ps
- Jitter higher than in Beta Set-Up, 52-62 ps

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25 **Dana** 

5936-4 Strip Sensor: 285  $\mu$ m thick, high leakage current (sensor broken in half), measured at 40 V





# TCT Set-Up for Timing

- Transient Current Technique: Charge created by a short laser pulse
- The current arising from the created e/h-pairs is amplified and then recorded with an oscilloscope
- Top-TCT: Laser on sensor surface, laser wavelength 1060 nm (infrared)
- First: Scanning the sensor area to determine the position of the columns
- For each specific position on the sensor: 3000 single events recorded
- Two pulses recorded per event: Using a fiber splitter and a cable (25 ns delay)







# **Time Resolution: Analysis**

- Maximum amplitude for each event filled into histogram MPV of the sensor is extracted with a Landau-Gauss-Fit
- If the maximum signal is above a threshold, events used for further analysis
- Time of Arrival determined with Constant Fraction Discrimination
- Linear fit around this point to extract the slope
- Determination of the rise time for each event by diving the maximum amplitude by the slope – mean of the distribution defines rise time





# Time Resolution: Analysis

- Noise level: Determined in a time span in the recorded waveform before the pulse
- Jitter: Sigma of a Gauss fit to the distribution of noise divided by slope
- Time Spread: Sigma of a Gauss fit to the distribution of the time difference between the two signals
- Time resolution can then be calculated



 $\sigma_{Ref} = 25.18 \pm 0.35 \ ps$ 

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# Time Resolution: 3D Pixel sensors

- Sanity Check: Comparison with/without additional PMT trigger
- With PMT: Very low rate pick-up noise problems
- Without PMT: overestimation of MPV
- Otherwise: Very comparable results
- All further measurements without PMT improved statistics and measurement time, while time resolution characteristics are maintained



Entrie

200

150

100

50

0.1

0.2

0.3

0.4

0.5

0.6

0.7



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#### 3D Pixel sensors



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